

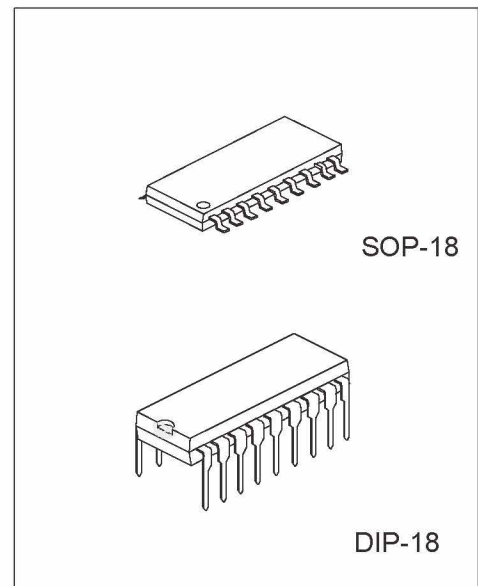
EIGHT HIGH VOLTAGE, HIGH CURRENT DARLINGTON ARRAYS

■ Description

The **ULN2804** is a high voltage, high current Darlington array comprised of eight NPN Darlington pairs. The device features open-collector outputs with suppression diodes for inductive loads and is ideally suited for interfacing between low-level logic circuitry and high power loads. Typical loads including relays DC motors, filament lamps, LED displays, printer hammers and high power buffers.

■ Features

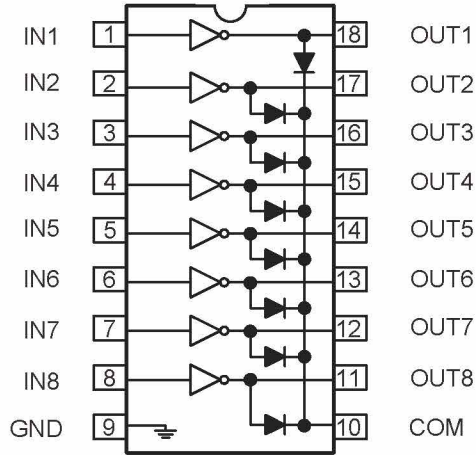
- TTL, PMOS or CMOS Compatible inputs
- Eight Darlington transistors with common emitters
- Output current to 500 mA
- Output voltage to 50 V
- Integral suppression diodes
- Versions for all popular logic families
- Output can be paralleled
- Inputs pinned opposite outputs to simplify board layout



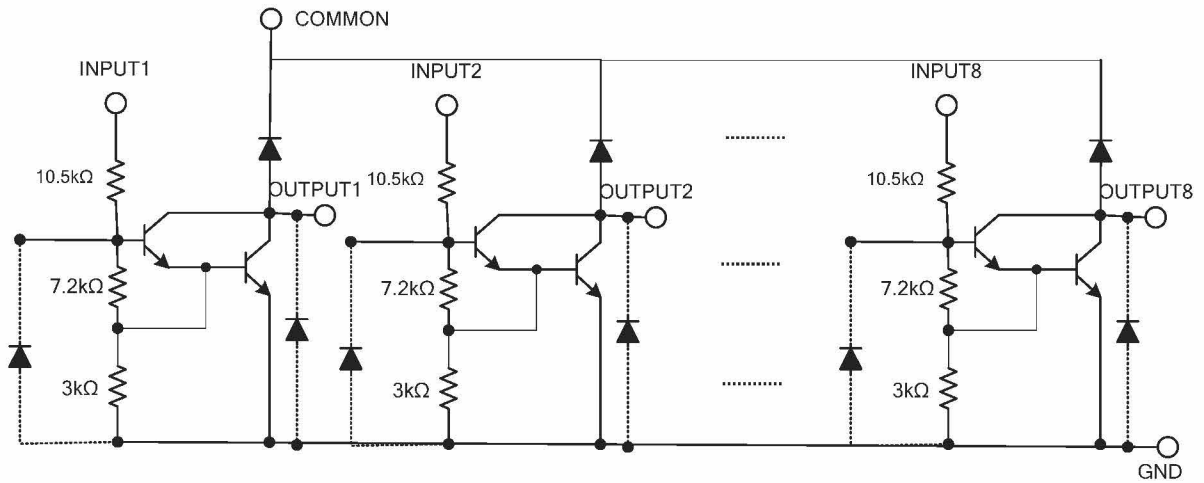
■ Ordering information

Part Number	Package	Packing	Temperature (T _A)	Package Qty	Note
ULN2804AN	DIP-18	Tube	-40°C ~ 85°C	1500	
ULN2804AD	SOIC-18	Reel	-40°C ~ 85°C	2000	

■ PIN Configurations



■ Schematics



■ Absolute Maximum Ratings

PARAMETER	SYMBOL	RATINGS	UNIT	
Input Voltage	V_{IN}	30	V	
Output Voltage	V_{OUT}	50	V	
Collector Current – Continuous	I_C	500	mA	
Base Current – Continuous	I_B	25	mA	
Power Dissipation	P_D	DIP-18	1.5	W
		SOP-18	0.95	W
Junction Temperature	T_J	+120	°C	
Operating Ambient Temperature	T_{OPR}	-40 ~ +85	°C	
Storage Temperature	T_{STG}	-55 ~ +150	°C	

Note Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied

■ Thermal data

PARAMETER	SYMBOL	RATING	UNIT	
Thermal resistance from junction to Ambient	θ_{JA}	DIP-18	60	°C/W
		SOP-18	80	°C/W

■ Electrical Characteristics ($T_a = 25^\circ\text{C}$, unless otherwise specified.)

PARAMETER	SYMBOL	TEST FIGURE	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
Collector-Emitter Saturation Voltage	$V_{CE(SAT)}$	1	$I_{OUT}=350\text{mA}, I_{IN}=500\mu\text{A}$		1.3	1.6	V	
			$I_{OUT}=200\text{mA}, I_{IN}=350\mu\text{A}$		1.1	1.3	V	
			$I_{OUT}=100\text{mA}, I_{IN}=250\mu\text{A}$		0.9	1.1	V	
Input Voltage	$V_{IN(ON)}$	2	$V_{CE}=2.0\text{V}$	$I_{OUT}=125\text{mA}$			5.0	V
				$I_{OUT}=200\text{mA}$			6.0	V
				$I_{OUT}=275\text{mA}$			7.0	V
				$I_{OUT}=350\text{mA}$			8.0	V
Clamp Diode Forward Voltage	V_F	3	$I_F=350\text{mA}$		1.5	2.0	V	
Output Leakage Current	I_{CEX}	4a	$V_{OUT}=50\text{V}, T_a=70^\circ\text{C}$			100	μA	
		4b	$V_{OUT}=50\text{V}, T_a=70^\circ\text{C}, V_{IN}=1.0\text{V}$			500	μA	
Input Current	ON	$I_{IN(ON)}$	5	$V_{IN}=5\text{V}$		0.35	0.5	mA
				$V_{IN}=12\text{V}$		1.0	1.45	mA
Clamp Diode Reverse Current	I_R	7	$V_R=50\text{V}, T_a=25^\circ\text{C}$			50	μA	
			$V_R=50\text{V}, T_a=70^\circ\text{C}$			100	μA	
DC Current Gain	h_{FE}		$V_{OUT}=2\text{V}, I_{OUT}=350\text{mA}$	1000				
Input Capacitance	C_{IN}				15	25	pF	
Turn-On Delay	t_{ON}	8			0.25	1	μs	
Turn-Off Delay	t_{OFF}	8			0.25	1	μs	

Test Figures

Figure 1.

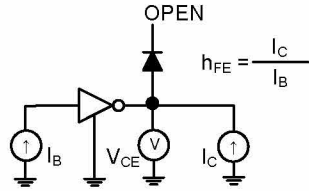


Figure 2.

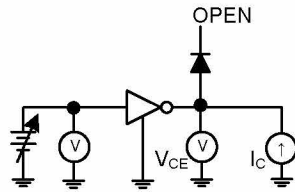


Figure 3.

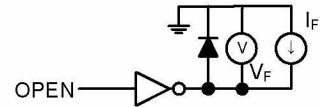


Figure 4a.

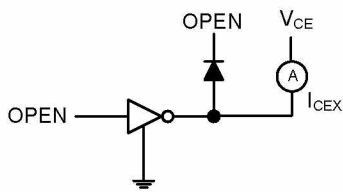


Figure 4b.

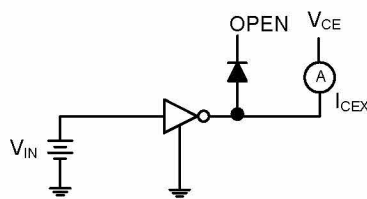


Figure 5.

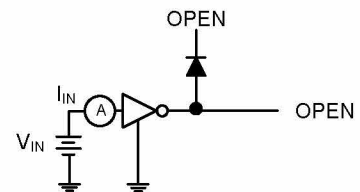


Figure 6.

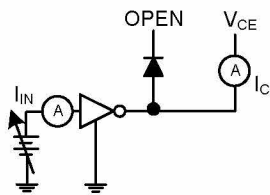


Figure 7.

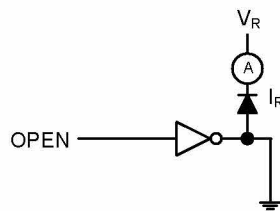
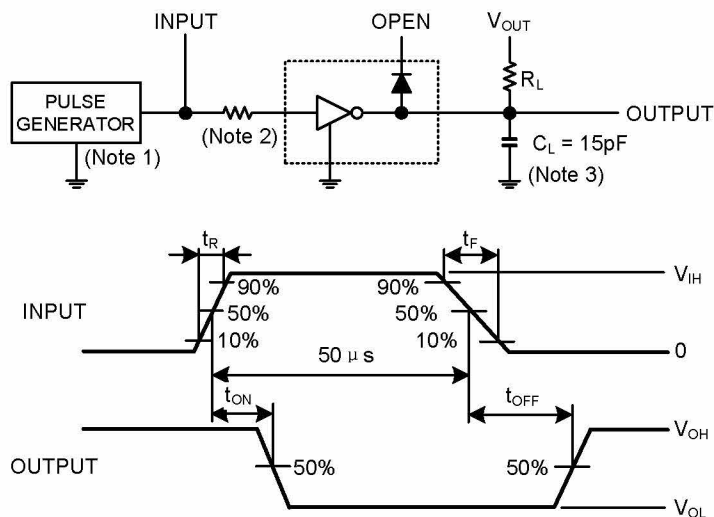


Figure 8.



Note1: Pulse width 50μs, duty cycle 10%

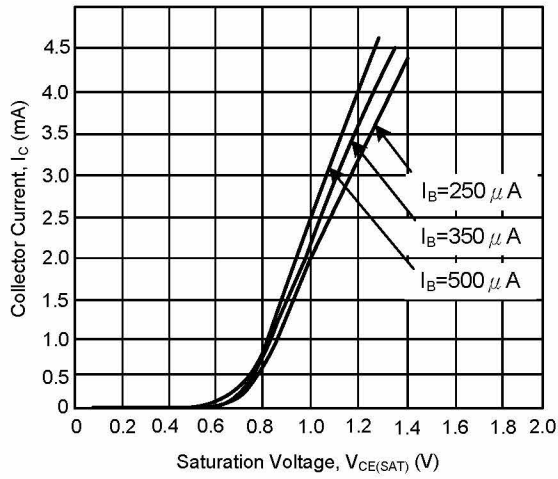
 Output impedance 50Ω, $t_R \leq 5\text{ns}$, $t_F \leq 10\text{ns}$

 Note2: $R_1: 0$, $V_{IH}: 3\text{V}$

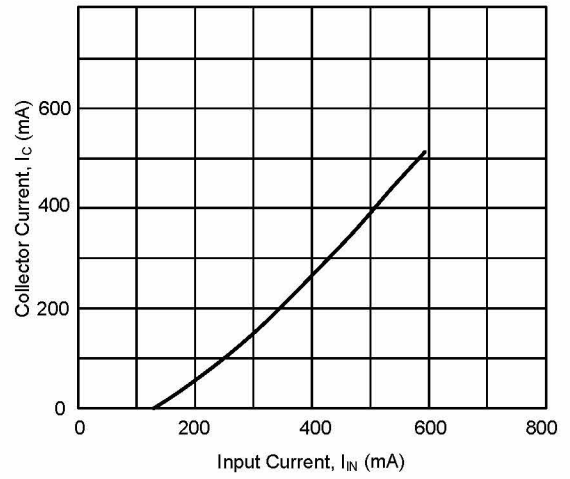
 Note3: C_L includes probe and jig capacitance.

■ **Typical Characteristics**

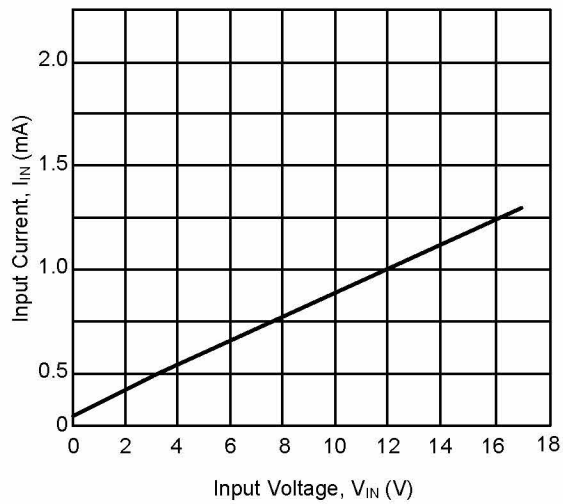
Output Current vs. Saturation Voltage



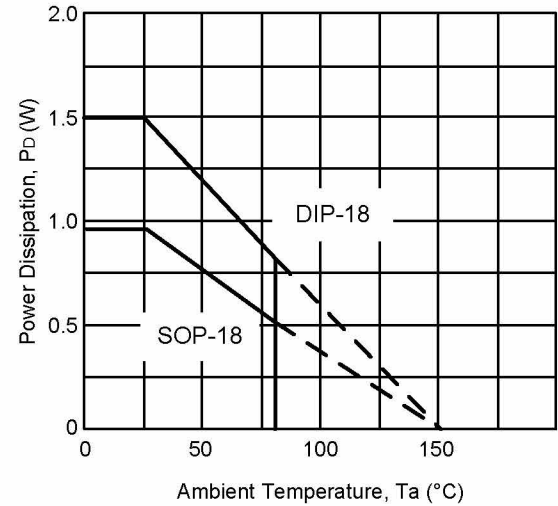
Output Current vs. Input Current



Input Current vs. Input Voltage



Power Dissipation vs. Ambient Temperature



DIP-18 mechanical data

Dim.	mm.		
	Min.	Typ.	Max.
a1	0.254		
B	1.39		1.65
b		0.46	
b1		0.25	
D			23.24
E		8.5	
e		2.54	
e3		20.32	
F			7.1
l			3.93
L		3.3	
Z		1.27	1.59

DIP-18 package dimensions
